



# N- and P-Channel 30-V (D-S) MOSFET

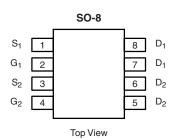
PRODUCT SUMMARY						
	V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)			
N-Channel	30	0.036 at V <sub>GS</sub> = 10 V	5.9			
	30	0.053 at V <sub>GS</sub> = 4.5 V	4.9			
P-Channel	- 30	0.053 at V <sub>GS</sub> = - 10 V	- 4.9			
	- 30	0.090 at V <sub>GS</sub> = - 4.5 V	- 3.7			

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC

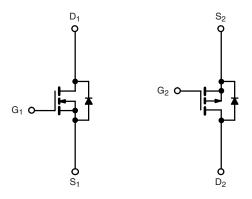






Ordering Information: Si4539ADY-T1-E3 (Lead (Pb)-free)

Si4539ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted								
			N-Channel		P-Channel			
Parameter	Symbol	10 s	Steady State	10 s	Steady State	Unit		
Drain-Source Voltage		$V_{DS}$	30		- 30		V	
Gate-Source Voltage		$V_{GS}$	± 20		± 20		ľ	
Continuous Dunin Comment /T 150 °C)	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	5.9	4.4	- 4.9	- 3.7	^	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		4.7	3.6	- 3.9	- 2.9		
Pulsed Drain Current		I <sub>DM</sub>	30				Α	
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	1.7	0.9	- 1.7	- 0.9		
M	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.0	1.1	2	1.1	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	'D	1.3	0.7	1.3	0.7		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C	

THERMAL RESISTANCE RATINGS									
			N-Ch	annel	P-Channel				
Parameter	Symbol	Тур.	Max.	Тур.	Max.	Unit			
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 10 s	R <sub>thJA</sub>	50	62.5	52	62.5			
	Steady State	' 'thJA	90	110	90	110	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	32	40	32	40			

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	therwise noted  Test Conditions			Max.	Unit	
Static		1					ı	
Gate Threshold Voltage		$V_{DS} = V_{GS}, I_D = 250 \mu A$	N-Ch	1.0			.,	
	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	P-Ch	- 1.0			V	
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	N-Ch			± 100	nA	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	P-Ch			± 100		
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V	N-Ch			1		
	I <sub>DSS</sub>	V <sub>DS</sub> = - 24 V, V <sub>GS</sub> = 0 V	P-Ch			- 1		
		V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	N-Ch			5	μΑ	
		V <sub>DS</sub> = - 24 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	P-Ch			- 5		
On-State Drain Current <sup>a</sup>	<b>†</b> .	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	30			1	
	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 30			A	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.9 A	N-Ch		0.032	0.036		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 4.9 A	P-Ch		0.043	0.053		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.9 A	N-Ch		0.042	0.053	Ω	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.7 A	P-Ch		0.075	0.090		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5.9 A	N-Ch		15		S	
		V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 4.9 A	P-Ch		9			
	V <sub>SD</sub>	I <sub>S</sub> = 1.7 A, V <sub>GS</sub> = 0 V	N-Ch		0.80	1.2	V	
Diode Forward Voltage <sup>a</sup>		I <sub>S</sub> = - 1.7 A, V <sub>GS</sub> = 0 V	P-Ch		- 0.80	- 1.2		
Dynamic <sup>b</sup>								
Total Gate Charge	Qg	N. Observati	N-Ch		13	20		
Total Gate Onlinge		N-Channel $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5.9 \text{ A}$	P-Ch		15	25	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.0 X	N-Ch		2.3			
		P-Channel	P-Ch		4			
Gate-Drain Charge		$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -4.9 \text{ A}$	N-Ch P-Ch		2 2.0			
			N-Ch	0.5	2.0	2.2	$\vdash$	
Gate Resistance	$R_g$		P-Ch	5		12.6	Ω	
	t <sub>d(on)</sub>	N-Channel	N-Ch		6	12		
Turn-On Delay Time			P-Ch		7	15	ns	
Rise Time		$V_{DD} = 15 \text{ V}, R_L = 15 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 6 \Omega$	N-Ch		14	25		
Tilde Tillie		$_{\rm ID} = 1 \text{ A}, \text{ VGEN} = 10 \text{ V}, \Pi_{\rm g} = 0.52$	P-Ch		10	20		
Turn-Off Delay Time Fall Time	t <sub>d(off)</sub>	P-Channel	N-Ch		30	60		
		$V_{DD} = -15 \text{ V}, R_L = 15 \Omega$	P-Ch		40	80		
	t <sub>f</sub>	$I_D \cong$ - 1 A, $V_{GEN}$ = - 10 V, $R_g$ = 6 $\Omega$	N-Ch P-Ch		5 20	10 40		
Source-Drain		I <sub>F</sub> = 1.7 A, dI/dt = 100 A/μs	N-Ch		30	60		
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 1.7 A, dl/dt = 100 A/μs	P-Ch		30	- 50	1	

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

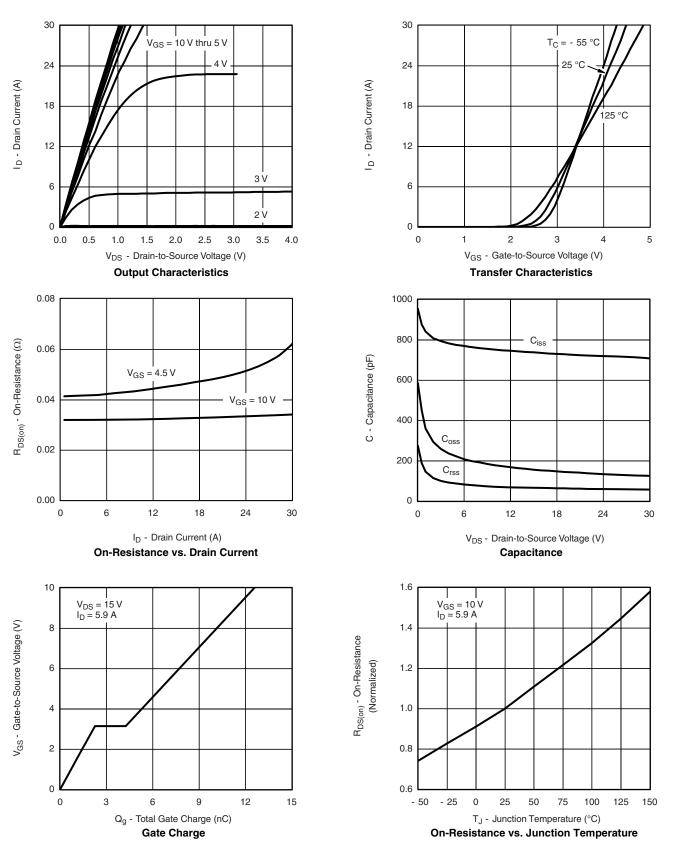
a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.





### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

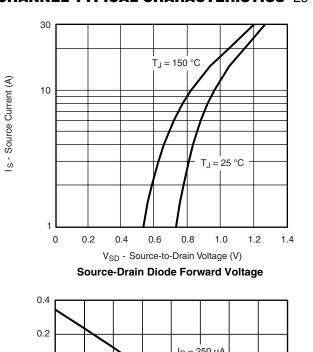


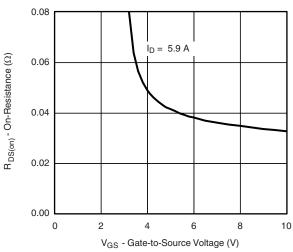
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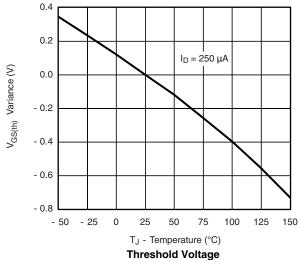
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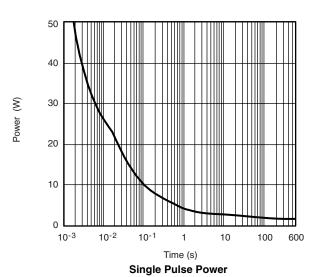
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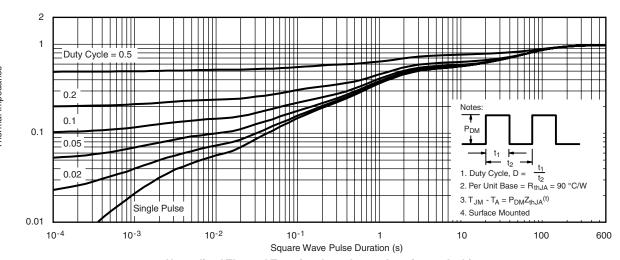








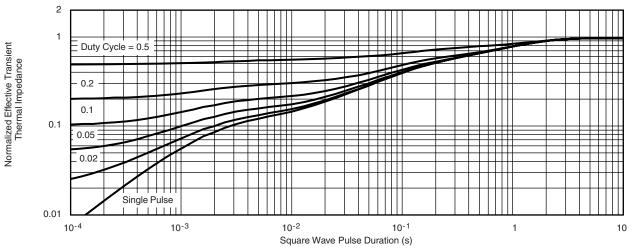




Normalized Thermal Transient Impedance, Junction-to-Ambient

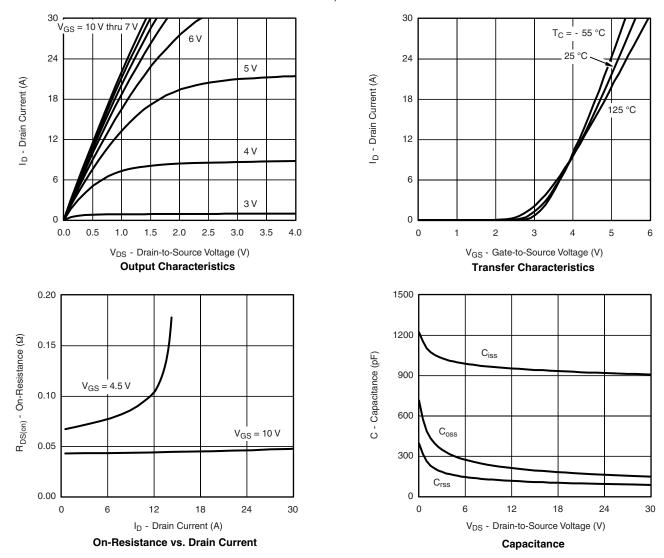


#### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

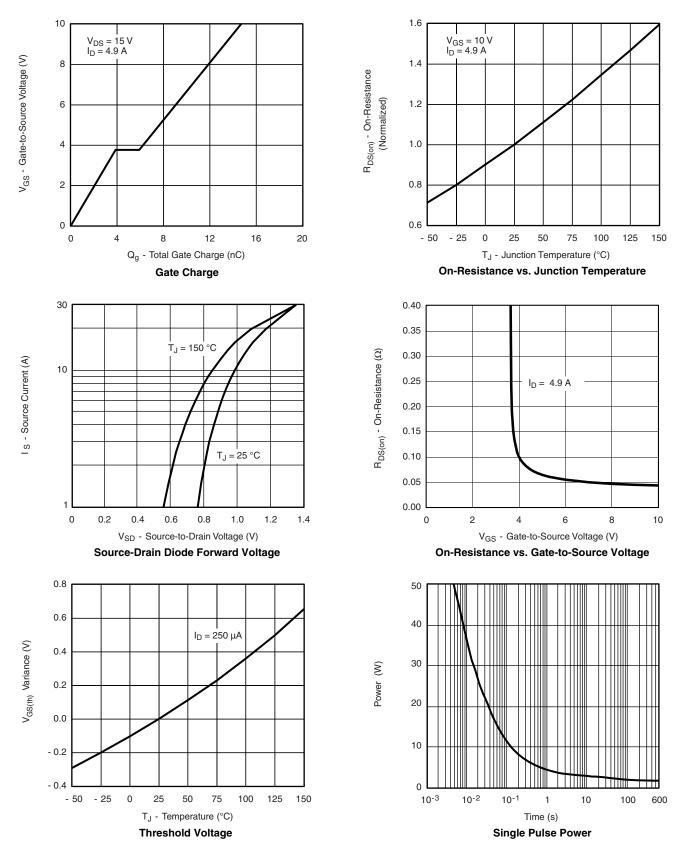


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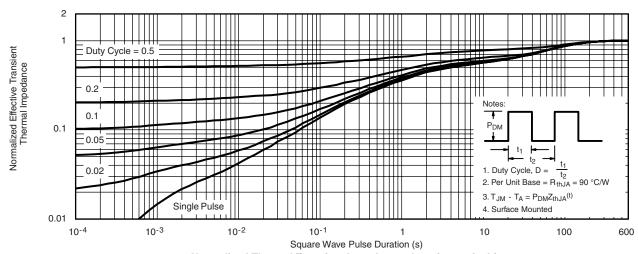


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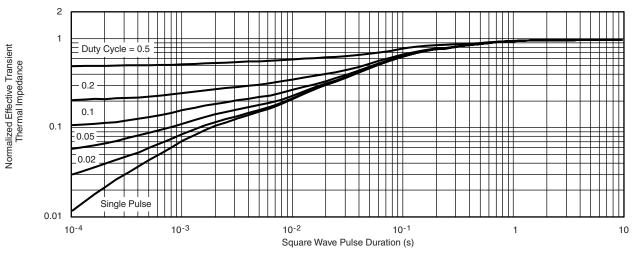




#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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